

C0805C681GATACTU

Aliases (C0805C681GATAC7800)

SMD Comm X8G HT150C, Ceramic, 680 pF, 2%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0805, 0.7 mm



General Information		
Series	SMD Comm X8G HT150C	
Style	SMD Chip	
Description	SMD, MLCC, High Temperature, Ultra-Stable	
Features	High Temperature, Ultra-Stable	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	11 mg	
Shelf Life	78 Weeks	
MSL	1	

680 pF

1 MHz 1.0Vrms

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
Т	0.78mm +/-0.10mm
S	0.7mm MIN
В	0.5mm +/-0.25mm

T	0.78mm +/-0.10mm
S	0.7mm MIN
В	0.5mm +/-0.25mm
Packaging Specifications	

W	1.25mm +/-0.2mm	Tolerance	2%
Т	0.78mm +/-0.10mm	Voltage DC	250 VDC
S	0.7mm MIN	Dielectric Withstanding Voltage	625 VDC
В	0.5mm +/-0.25mm	Temperature Range	-55/+150°C
		Temp. Coefficient	X8G
Packaging Specifications		Capacitance Change with	30 ppm/C, 1MegaHz 1.0Vrms
Packaging	T&R, 180mm, Paper Tape	Reference to +25°C and 0 VDC Applied (TCC)	
Packaging Quantity 4000	Dissipation Factor	0.1% 1 MHz 1.0Vrms	
		Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
		Insulation Resistance	100 GOhms

Specifications

Measurement Condition

Capacitance

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Generated 05/05/2025 © 2006 - 2025 YAGEO